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Atty. Docket No. 042390P3955D

PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of:

Andideh, Ebrahim et al.

Application No.: 09/436,092

Filed: November 8, 1999

For: POLISH PAD WITH NON-UNIFORM  
GROOVE DEPTH TO IMPROVE WAFER  
POLISH RATE UNIFORMITY

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)  
) Examiner: McDonald, Shantese L.

)  
) Art Unit: 3723  
)  
)

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

**STATUS INQUIRY**

Sir:

Applicants respectfully request information concerning the status of the above-referenced application. MPEP § 102.

An amendment was timely filed for this application on May 21, 2004 in response to a non-final Office Action dated February 24, 2004.

A postcard was subsequently returned to the Applicants by the Office of Initial Patent Examination (OIPE) of the USPTO acknowledging receipt on May 24, 2004. MPEP § 503.

Applicants have checked the Patent Application Information Retrieval (PAIR) system of the USPTO. The PAIR system confirmed that Applicants' reply has not been followed by any other activity. MPEP § 1730 (II) (C).


Since no correspondence had been received from the Examiner in the ensuing 6 months, Applicants contacted the Examiner today. MPEP § 203.08 (II).

During the telephone call, the Examiner indicated that the amendment had not yet been entered. However, the Examiner stated that someone would be sent to get the file.

Applicants hereby respectfully request the Examiner to provide an expected date of when action will be taken on this application.

Respectfully submitted,  
BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN

Date: November 16, 2004

  
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